



THIN FILM SURFACE MOUNT

# Band Pass Filter

## ABF-8R75G+

Mini-Circuits

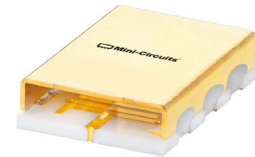
50Ω 8.6 to 8.9 GHz

### KEY FEATURES

- Low Passband Insertion Loss of 1.3dB Typ.
- High Rejection of 50dB Typ.
- Good Return Loss of 15dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

### APPLICATIONS

- X-Band Radar System for Naval Defense
- Test and Measurement Equipment

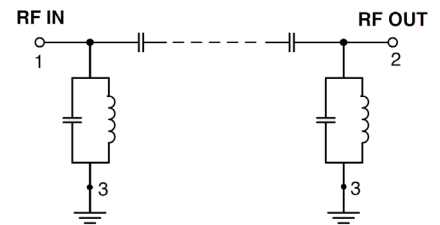


Generic photo used for illustration purposes only

### PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

### FUNCTIONAL DIAGRAM



### ELECTRICAL SPECIFICATIONS<sup>1,2</sup> AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Pass Band	Center Frequency <sup>3</sup>	—	—	—	8.75	—	GHz
	Insertion Loss	F1-F2	8.6 - 8.9	—	1.3	2.5	dB
	Return Loss	F1-F2	8.6 - 8.9	—	15	—	dB
Stop Band, Lower	Rejection	DC-F3	DC - 6.5	40	50	—	dB
		F3-F4	6.5 - 7.4	20	35	—	
Stop Band, Upper	Rejection	F5-F6	10.2 - 12	20	38	—	dB
		F6-F7	12 - 16	40	47	—	
		F7-F8	16 - 20	—	35	—	

1. Tested on Evaluation Board P/N TB-ABF-8R75G+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. Typical variation. ±3%

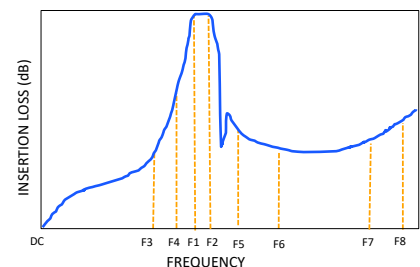
### ABSOLUTE MAXIMUM RATINGS<sup>4</sup>

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power <sup>5</sup>	1W Max. at 25°C

4. Permanent damage may occur if any of these limits are exceeded.

5. Power rating applies only to signals within the passband.

### TYPICAL FREQUENCY RESPONSE AT +25°C





THIN FILM SURFACE MOUNT

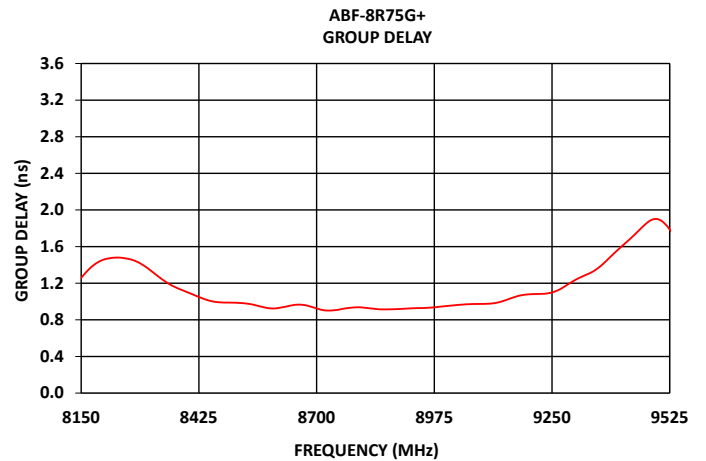
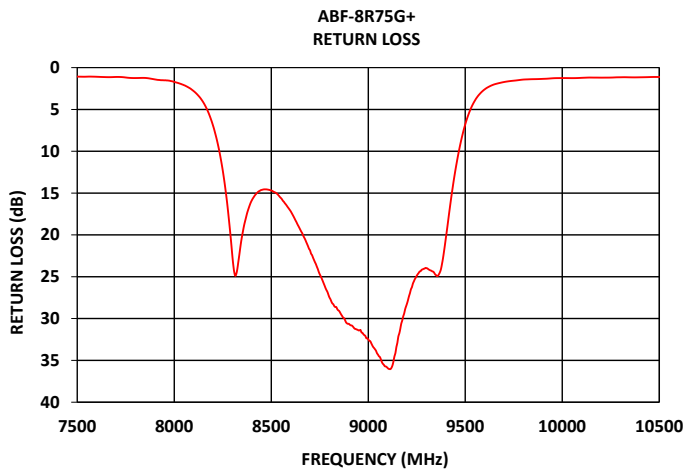
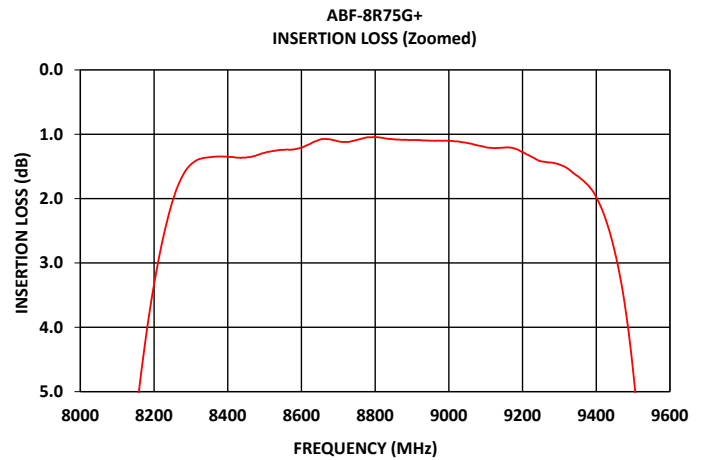
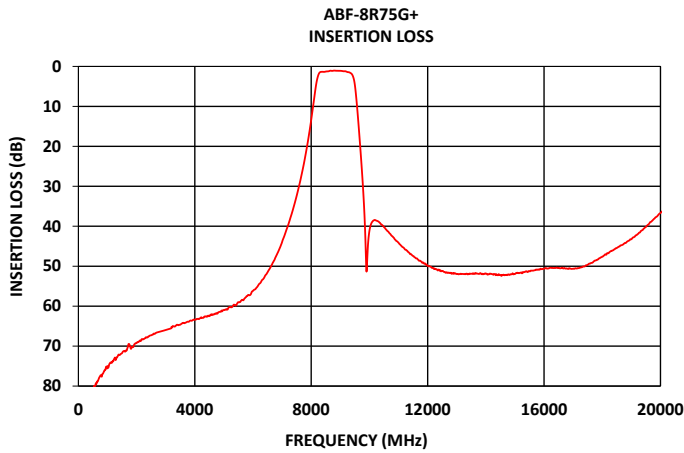
# Band Pass Filter

## ABF-8R75G+

Mini-Circuits

50Ω 8.6 to 8.9 GHz

### TYPICAL PERFORMANCE GRAPHS AT +25°C





### FUNCTIONAL DIAGRAM

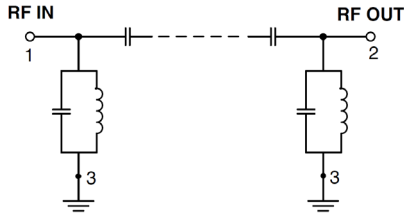
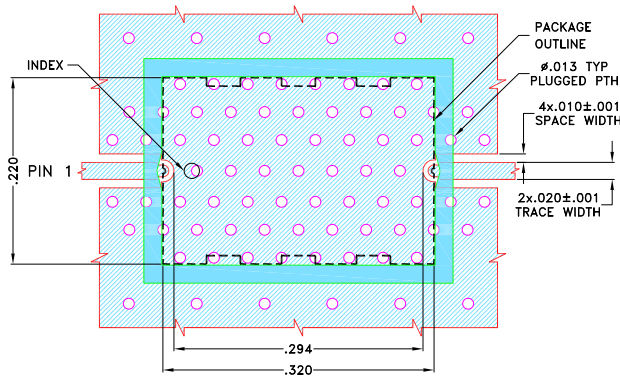


Figure 1. ABF-8R75G+ Functional Diagram

### PAD DESCRIPTION

Function	Pad Number	Description
RF <sub>1</sub> (Note 2)	1	Connects to RF Input Port
RF <sub>2</sub> (Note 2)	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-652)
NC	—	No connection, not used internally. See drawing PL-652 for connection to PCB

### SUGGESTED PCB LAYOUT (PL-652)

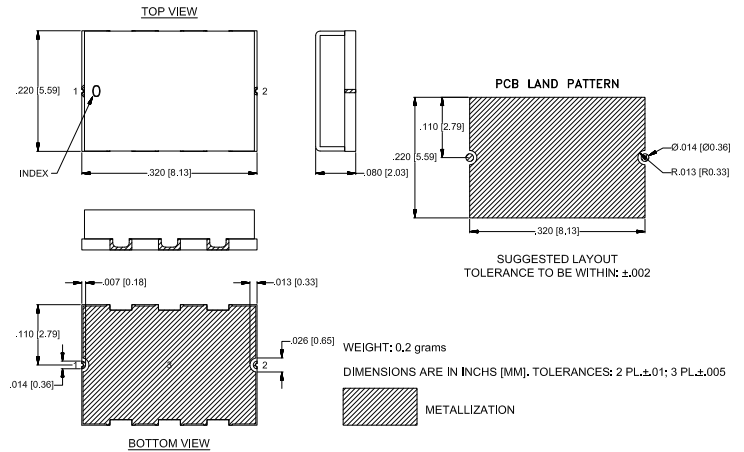


#### NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
  - DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
  - DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-652

### CASE STYLE DRAWING

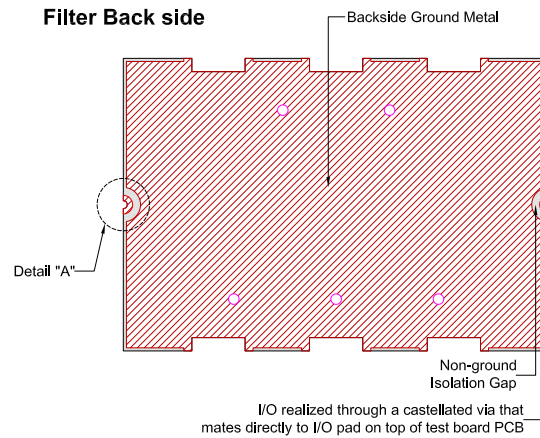


### PRODUCT MARKING\*: ABF-8R75G

\*Marking may contain other features or characters for internal lot control.

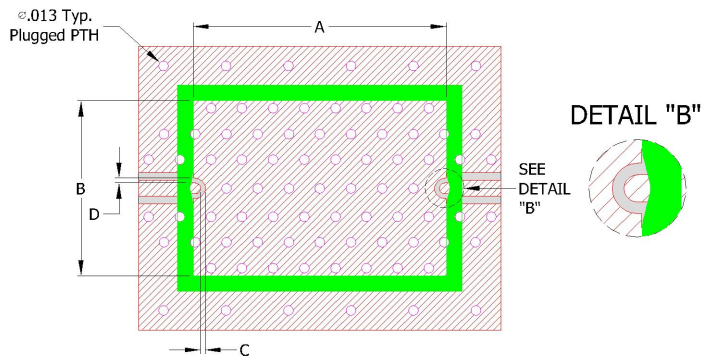
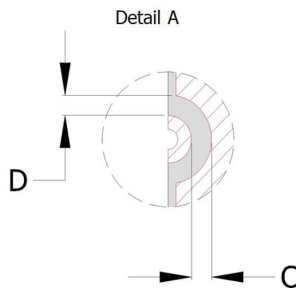


### RECOMMENDED PCB LAYOUT PATTERN FOR FILTER



### PCB Pattern Recommendations

Filter RF I/O Detail (Filter Back Side)



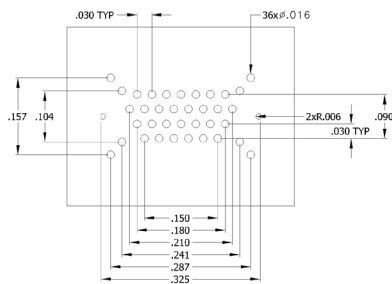
- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
- 5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).



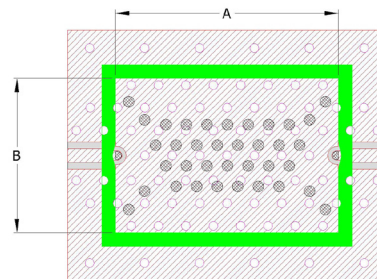
### COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.



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# Band Pass Filter

## ABF-8R75G+

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50Ω 8.6 to 8.9 GHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

[CLICK HERE](#)

Performance Data and Graphs	Data
	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	UC2731 Lead Finish: Gold over Nickel Plate.
RoHS Status	Compliant
Tape and Reel	TR-F003
Suggested Layout for PCB Design	PL-652
Evaluation Board	TB-ABF-8R75G+
	Gerber File
Environmental Rating	ENV120

### NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/terms/viewterm.html](http://www.minicircuits.com/terms/viewterm.html)



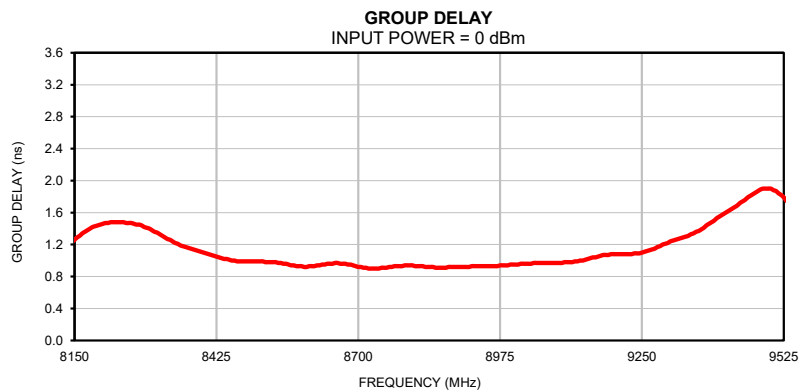
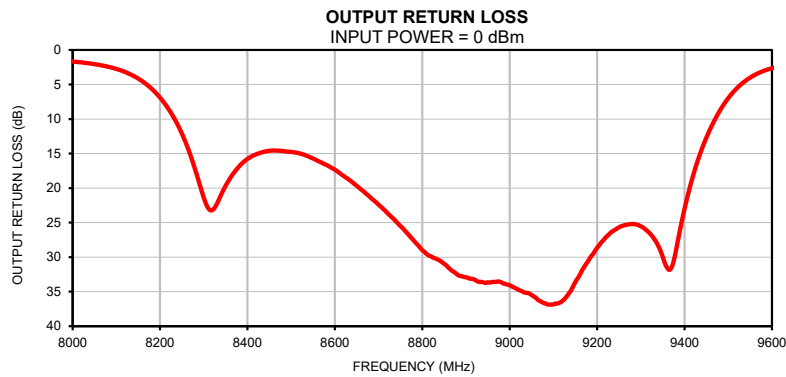
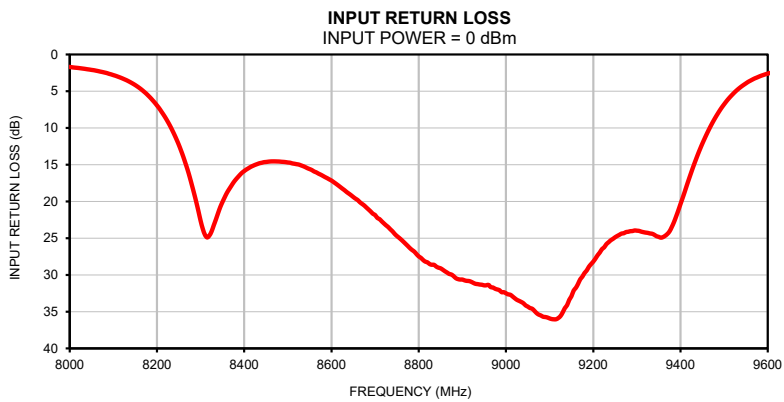
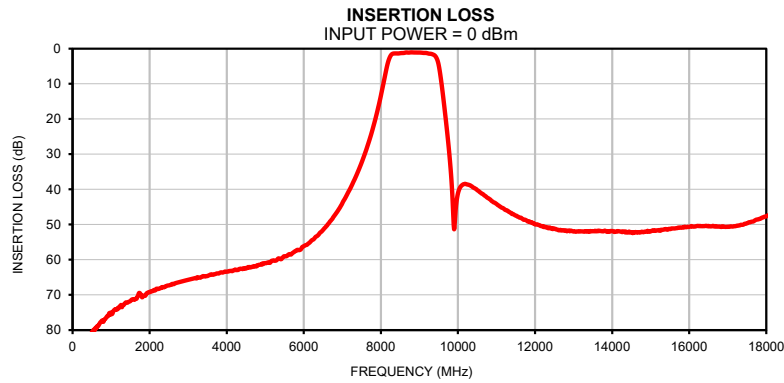
# Thin-Film Bandpass Filter

# ABF-8R75G+

## Typical Performance Data

FREQ.	Insertion Loss	Input Return Loss	Output Return Loss	FREQ.	Group Delay
(MHz)	(dB)	(dB)	(dB)	(MHz)	(ns)
10	107.02	0.08	0.09	8600	0.92
15	107.18	0.08	0.10	8605	0.93
40	97.62	0.12	0.11	8610	0.93
100	94.74	0.05	0.07	8615	0.93
160	91.25	0.14	0.16	8620	0.94
200	88.75	0.15	0.17	8625	0.94
300	84.76	0.21	0.23	8630	0.95
400	82.61	0.25	0.26	8635	0.95
500	80.60	0.27	0.29	8640	0.96
600	79.28	0.28	0.29	8645	0.96
700	78.17	0.31	0.31	8650	0.96
800	77.66	0.35	0.35	8655	0.97
900	76.04	0.34	0.34	8660	0.97
1000	74.98	0.34	0.34	8665	0.96
1500	71.75	0.35	0.35	8670	0.96
2000	69.26	0.35	0.34	8675	0.96
2500	67.30	0.31	0.33	8680	0.95
2580	66.90	0.31	0.29	8685	0.95
3500	64.64	0.31	0.31	8690	0.94
4000	63.40	0.39	0.38	8695	0.93
5000	60.96	0.62	0.63	8700	0.92
6000	56.14	0.80	0.74	8705	0.92
6500	51.51	0.88	0.82	8710	0.91
7400	35.09	1.07	0.99	8715	0.91
7500	32.38	1.07	1.03	8720	0.90
7600	29.38	1.09	1.02	8725	0.90
7640	28.08	1.13	1.09	8730	0.90
7660	27.40	1.14	1.10	8735	0.90
7680	26.73	1.13	1.11	8740	0.90
7700	26.05	1.12	1.10	8745	0.91
7760	23.88	1.21	1.14	8750	0.91
7800	22.31	1.25	1.22	8755	0.91
8000	13.35	1.70	1.66	8760	0.92
8195	3.50	6.57	6.54	8765	0.92
8260	1.87	13.87	13.63	8770	0.93
8600	1.21	17.16	17.34	8775	0.93
8610	1.18	17.58	17.79	8780	0.93
8650	1.08	19.40	19.68	8785	0.93
8700	1.11	21.85	22.41	8790	0.94
8720	1.12	22.98	23.61	8795	0.94
8750	1.09	24.71	25.51	8800	0.94
8800	1.04	27.48	28.99	8805	0.94
8850	1.08	29.10	30.97	8810	0.93
8900	1.09	30.63	32.91	8815	0.93
9000	1.10	32.50	34.07	8820	0.93
9480	3.75	8.58	8.87	8825	0.93
9600	12.24	2.60	2.65	8830	0.92
9700	21.77	1.72	1.73	8835	0.92
10200	38.47	1.20	1.15	8840	0.92
11500	47.45	1.09	1.04	8845	0.92
12000	49.95	1.07	1.03	8850	0.91
12500	51.26	1.04	1.03	8855	0.91
13000	51.89	1.04	0.94	8860	0.91
13500	51.89	1.08	1.01	8865	0.91
14000	51.82	1.16	1.11	8870	0.91
14500	52.15	1.25	1.20	8875	0.92
16000	50.66	1.23	1.22	8880	0.92
16500	50.38	1.16	1.17	8885	0.92
17000	50.65	1.14	1.12	8890	0.92
20000	36.68	1.75	1.65	8900	0.92

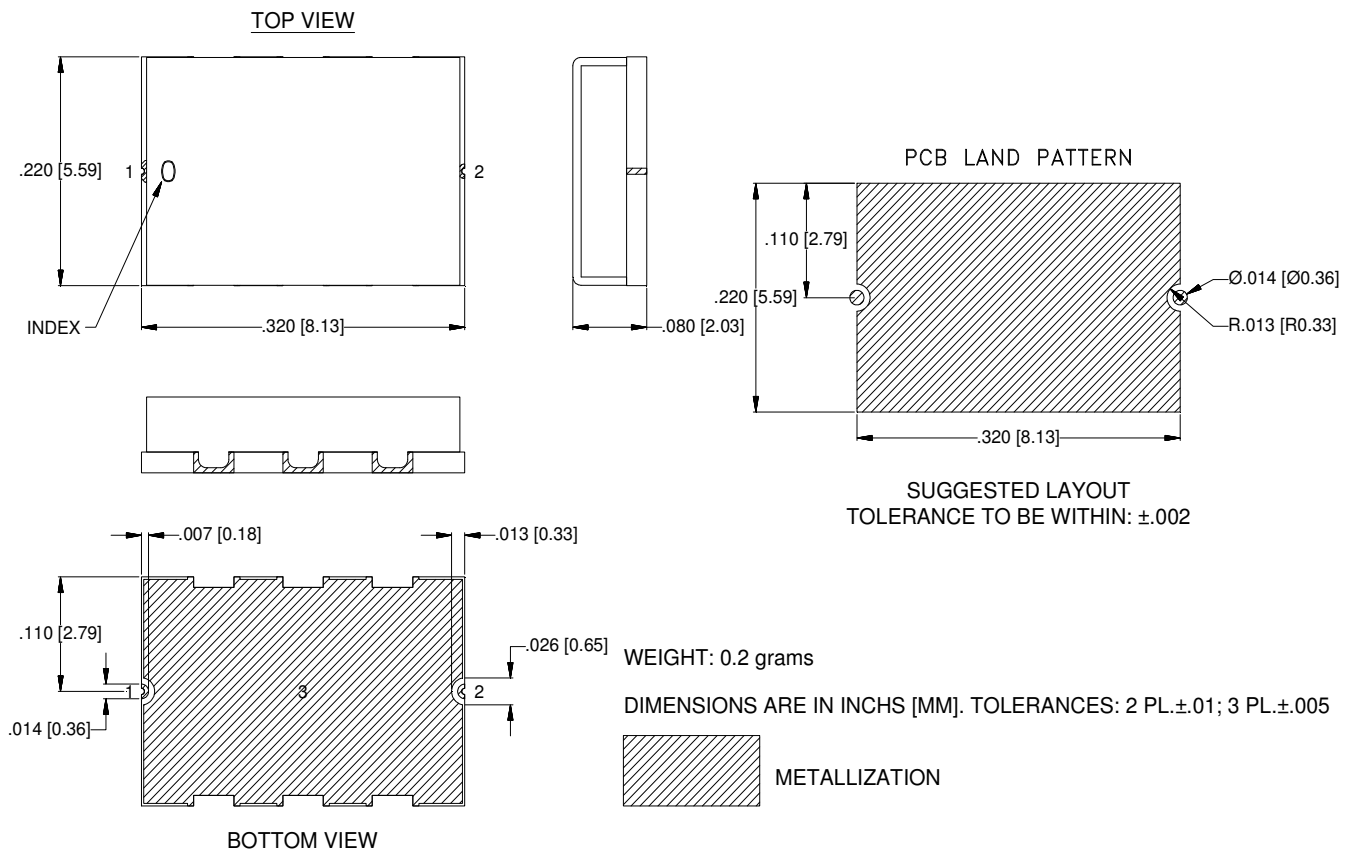
Typical Performance Curves





## Outline Dimensions

## UC2731



### Notes:

1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**  
For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.



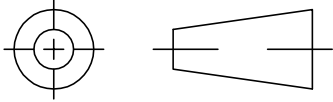
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: [www.minicircuits.com](http://www.minicircuits.com)

RF/IF MICROWAVE COMPONENTS

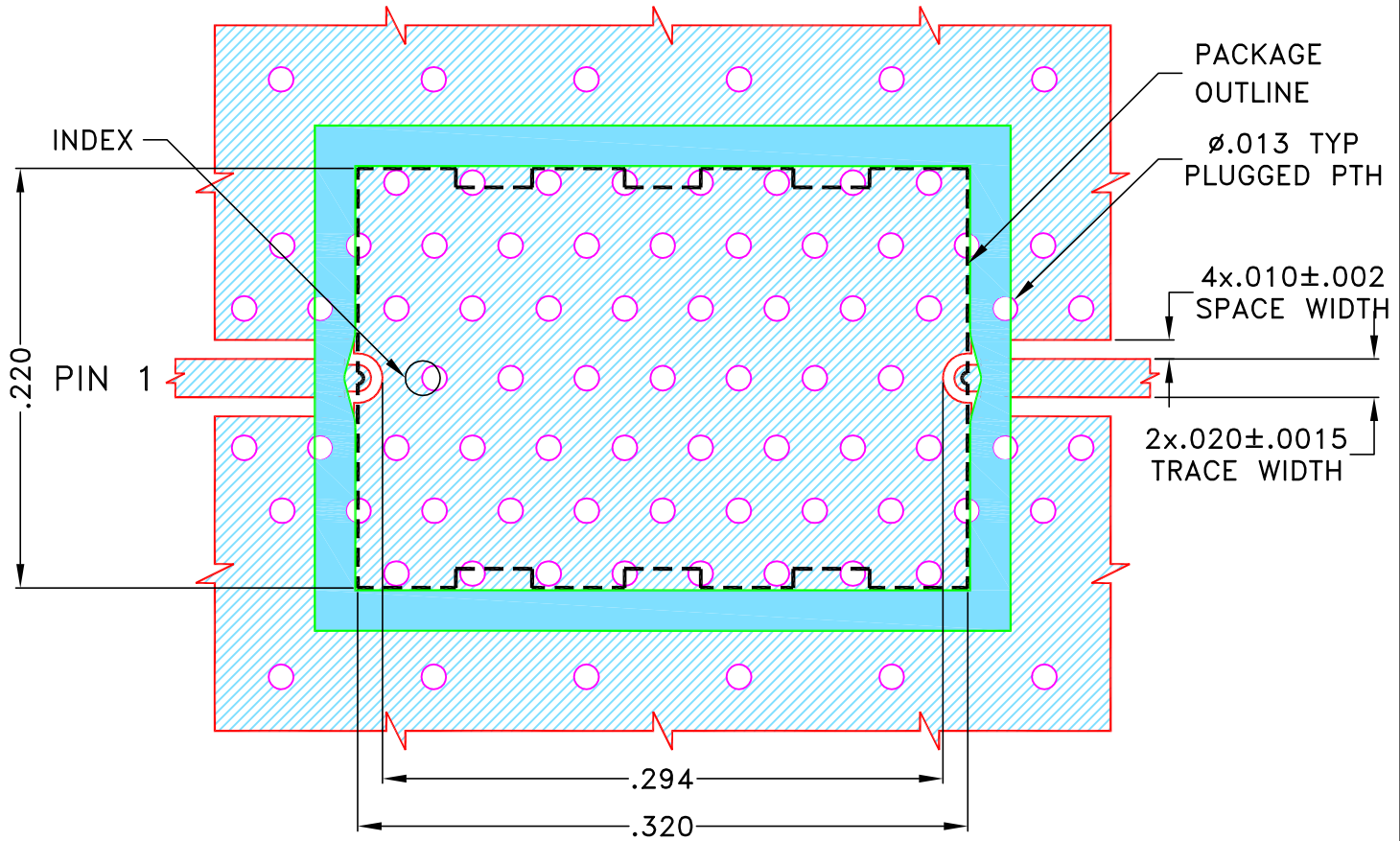
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-007104	NEW RELEASE	MAR 21	DDR	VC
A	ECO-010633	UPDATED AS PER CURRENT TEST BOARD	NOV 21	DDR	VC

**SUGGESTED MOUNTING CONFIGURATION  
FOR UC2731 CASE STYLE**



**NOTES:**

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS  $.010 \pm .0010$ . COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)  
 DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN: DDR	29 MAR 21
TOLERANCES ON:	CHECKED: RR	29 MAR 21
2 PL DECIMALS ±	APPROVED: NN	29 MAR 21
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

**Mini-Circuits®** 13 Neptune Avenue  
Brooklyn NY 11235

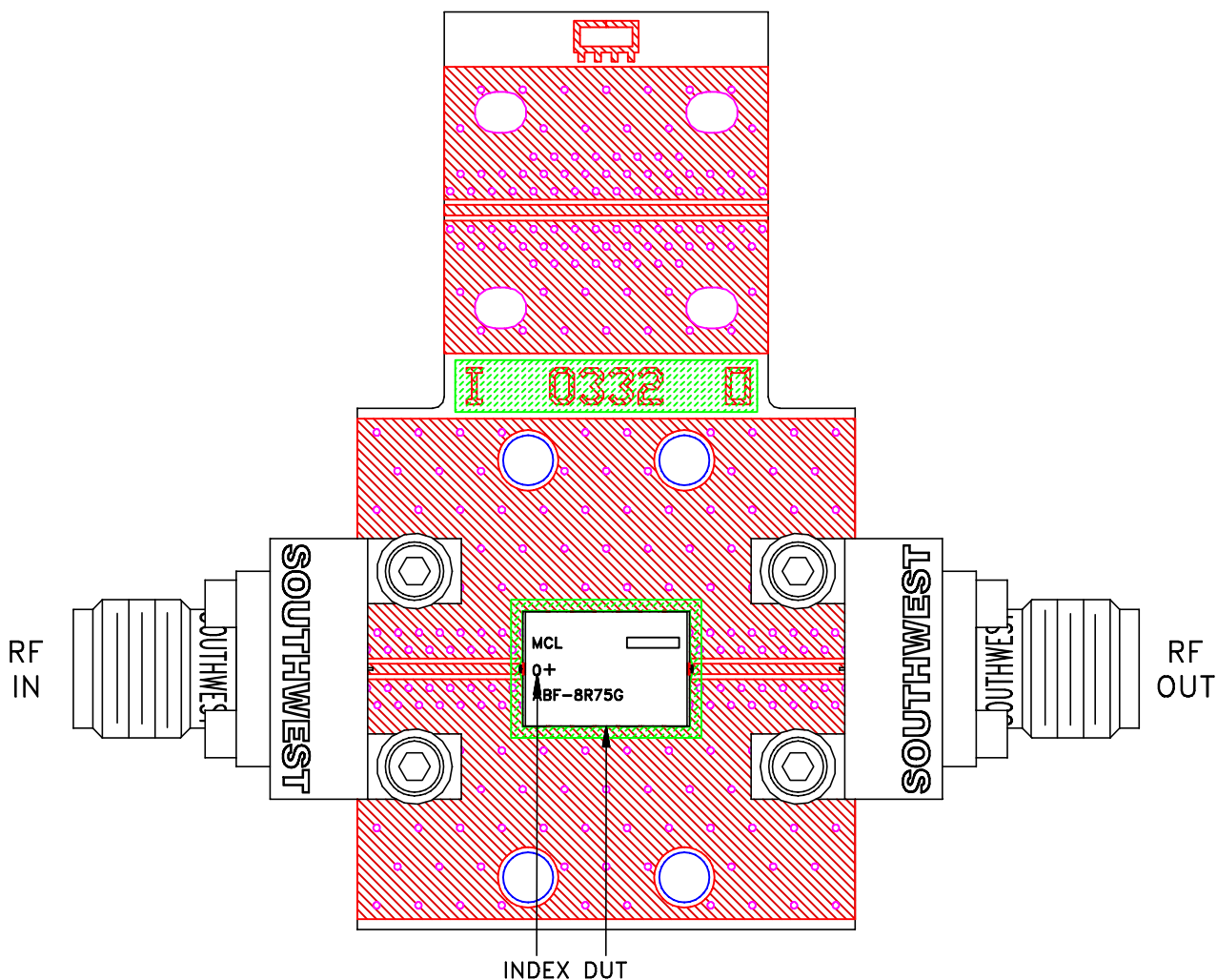
PL DWG, UC2731 C.S, 50 OHM, ABF

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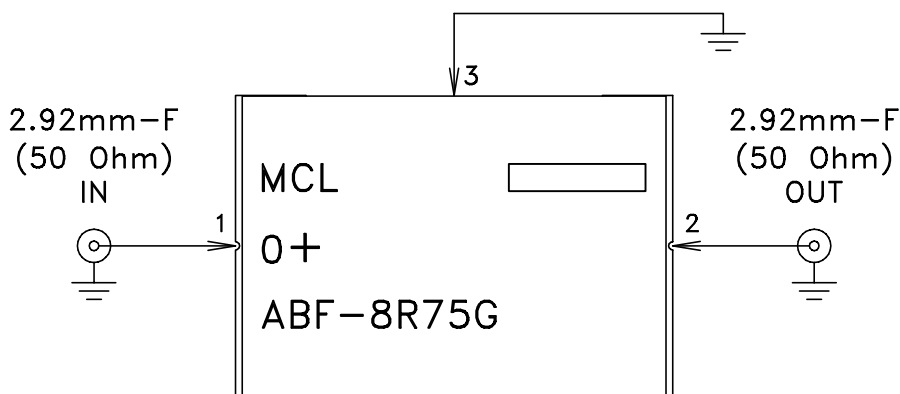
SIZE: A	CODE IDENT: 15542	DRAWING NO: 98-PL-652	REV: A
FILE: 98-PL-652	SCALE: 10:1	SHEET: 1 OF 1	

# Evaluation Board and Circuit

TB-ABF-8R75G+




Schematic diagram



**Notes:**

1. PCB Material: ROGERS (R04350B) OR Equivalent, Dielectric Constant=3.48±.05  
Dielectric Thickness: .010±.001 inch
2. 50 Ohm 2.92mm Female Connectors.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

<b>Specification</b>	<b>Test/Inspection Condition</b>	<b>Reference/Spec</b>
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C